MA3X721 (MA721)

Silicon epitaxial planar type

For super high speed switching For small current rectification

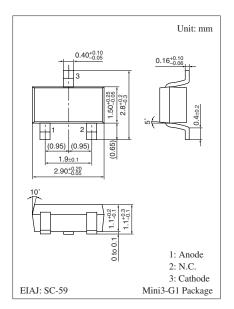
■ Features

• Forward current (Average) $I_{F(AV)} = 200$ mA rectification is possible

■ Absolute Maximum Ratings $T_a = 25$ °C

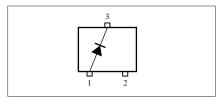
| Parameter | Symbol | Rating | Unit |
|---|------------------|-------------|------|
| Reverse voltage | V_R | 30 | V |
| Maximum peak reverse voltage | V_{RM} | 30 | V |
| Forward current | I_F | 200 | mA |
| Peak forward current | I_{FM} | 300 | mA |
| Non-repetitive peak forward surge current * | I _{FSM} | 1 | A |
| Junction temperature | T _j | 150 | °C |
| Storage temperature | T_{stg} | -55 to +150 | °C |

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



Marking Symbol: M1M

Internal Connection

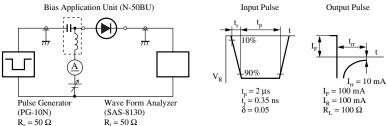


■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|-------------------------|-----------------|--|-----|-----|------|------|
| Forward voltage | V_F | $I_F = 200 \text{ mA}$ | | | 0.55 | V |
| Reverse current | I_R | $V_R = 30 \text{ V}$ | | | 50 | μΑ |
| Terminal capacitance | C _t | $V_R = 0 V, f = 1 MHz$ | | 30 | | pF |
| Reverse recovery time * | t _{rr} | $I_F = I_R = 100 \text{ mA}$ | | 3.0 | | ns |
| | | $I_{rr} = 10 \text{ mA}, R_{L} = 100 \Omega$ | | | | |

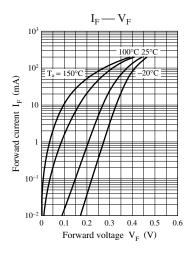
 $Note) \ 1. \ Measuring \ methods \ are \ based \ on \ JAPANESE \ INDUSTRIAL \ STANDARD \ JIS \ C \ 7031 \ measuring \ methods \ for \ diodes.$

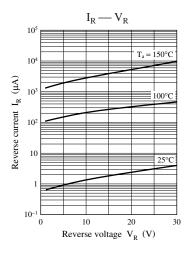
- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. Absolute frequency of input and output is 1 GHz.
- 4. *: t_{rr} measurement circuit

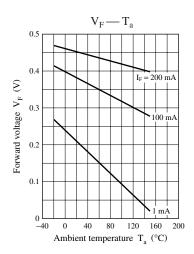


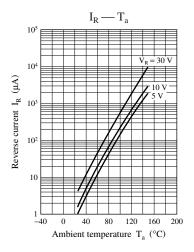
Note) The part number in the parenthesis shows conventional part number.

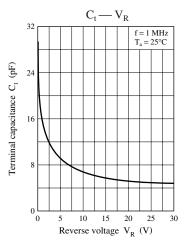
Panasonic











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